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LX5506M

# InGaP HBT 4.5 - 6GHz Power Amplifier

**PRODUCTION DATA SHEET** 

### **DESCRIPTION**

GHz frequency range. implemented as monolithic microwave chip input matching and output pre- VSWR. matching. The device is manufactured positive voltage supply of 3.3V EVM of -30dB for up to +18dBm applications. output power in the 4.9-5.9GHz band.

LX5506M features high gain of up to 30dB with low quiescent current of 90mA, and high power added efficiency of up to 20% at maximum

The LX5506M is a power amplifier linear output power for OFDM mask optimized for the FCC Unlicensed compliance. It also features an on-chip National Information Infrastructure output power detector to help reduce (U-NII) band, HyperLAN2 and Japan BOM cost and board space in system WLAN applications in the 4.9-5.9 implementation. The on-chip detector The PA is allows simple interface with an external three-stage directional coupler, providing accurate integrated output power level readings insensitive circuit (MMIC) with active bias, on- to frequency, temperature, and load

LX5506M is available in a 16-pin with an InGaP/GaAs Heterojunction 3mmx3mm micro-lead package (MLP). Bipolar Transistor (HBT) IC process The compact footprint, low profile, and (MOCVD). It operates with a single excellent thermal capability of the MLP package makes LX5506M an ideal (nominal), with up to +22dBm linear solution for broadband, high-gain output power for 802.11a OFDM power amplifier requirements for IEEE spectrum mask compliance, and low 802.11a, and Hiperlan2 portable WLAN

**IMPORTANT:** For the most current data, consult *MICROSEMI*'s website: <a href="http://www.microsemi.com">http://www.microsemi.com</a>

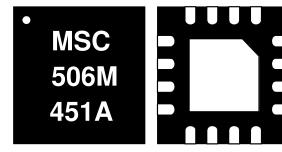
### **KEY FEATURES**

- Broadband 4.9-5.9GHz Operation
- Advanced InGaP HBT
- Single-Polarity 3.3V Supply
- Power Gain ~ 30dB at 5.25GHz
- Power Gain > ~28dB across 4.9-5.9GHz
- EVM ~ -30dB at Pout=+17dBm at 5.25GHz
- EVM ~ -30dB at Pout=+18dBm at 5.85GHz
- Total Current ~140mA for Pout= +17dBm at 5.25GHz (For High Duty Cycle of 90%)
- Maximum Linear Power ~ +22dBm for OFDM Mask Compliance
- Maximum Linear Efficiency ~ 20%
- On-chip Output Power Detector with Improved Frequency and Load-VSWR Insensitivity
- On-Chip Input Match
- On-Chip RF Decoupling
- Simple Output Match for Optimal Broadband EVM
- Small Footprint: 3x3mm<sup>2</sup>
- Low Profile: 0.9mm

#### **APPLICATIONS**

- FCC U-NII Wireless
- IEEE 802.11a
- HiperLAN2
- 5GHz Cordless Phone

# PRODUCT HIGHLIGHT



# PACKAGE ORDER INFO **Plastic MLPQ** 16 pin

RoĤS Compliant / Pb-free LX5506MLQ

Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. LX5506MLQ-TR)

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## INFORMATION

Thank you for your interest in Microsemi® Analog Mixed Signal products.

The full data sheet for this device contains proprietary information.

To obtain a copy, please contact your local Microsemi sales representative. The name of your local representative can be obtained at the following link <a href="http://www.microsemi.com/contact/contactfind.asp">http://www.microsemi.com/contact/contactfind.asp</a>

or

Contact us directly by sending an email to:

IPGdatasheets@microsemi.com

Be sure to specify the data sheet you are requesting and include your company name and contact information and or vcard.

We look forward to hearing from you.